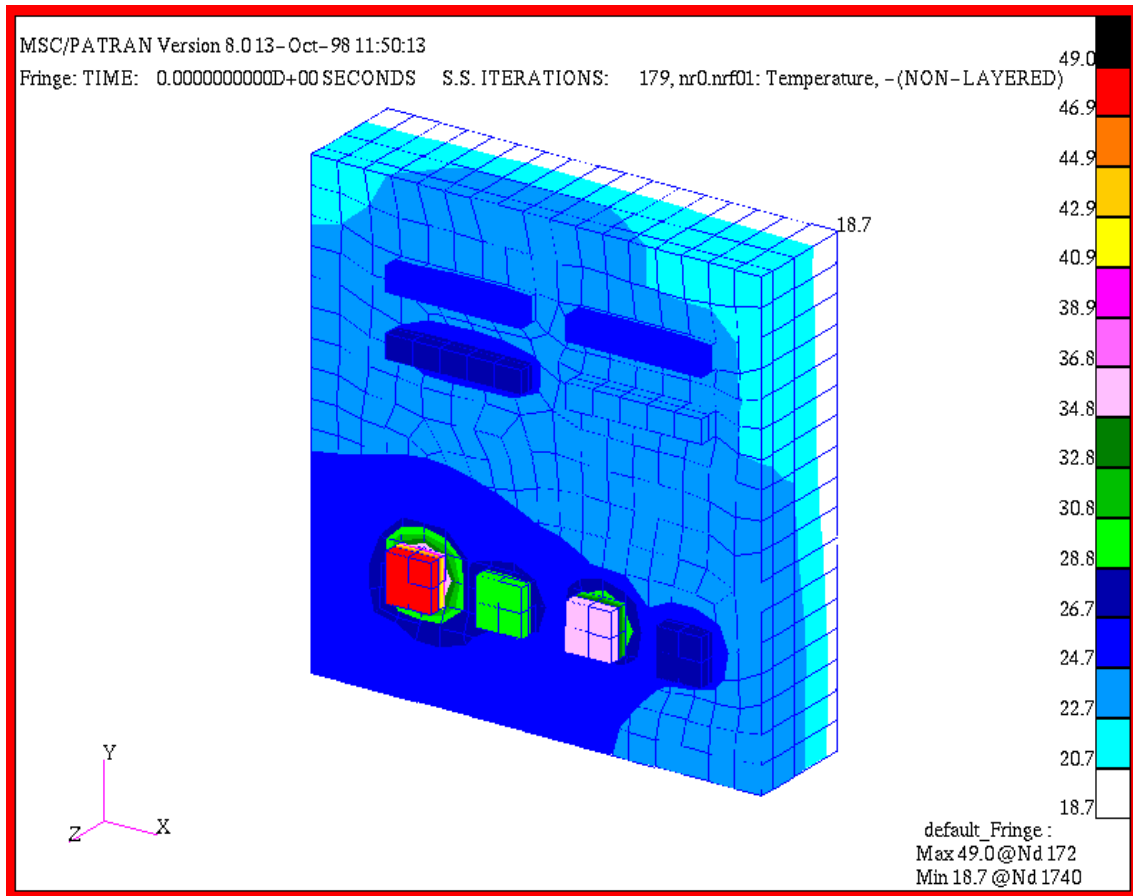


WORKSHOP 9

Thermal Analysis of the Hybrid Microcircuit



Objective:

- In this exercise you complete a steady state thermal analysis of the 3D hybrid microcircuit.



Model Description:

In this exercise complete the analysis of a hybrid microcircuit which is subjected to a bench functional test. The hybrid is clamped to a test fixture which is chilled by iced water. The microcircuit is continuously flushed by a dry nitrogen purge at **21°C**.

During functional testing, which takes approximately **1 hour**, the entire hybrid dissipates **8 watts**. Each device dissipates a constant wattage, as listed. The goal of the analysis is to verify that all device temperature shall remain below **50°C**.

Exercise Overview:

- Open the existing database named **microcircuit.db**.
- Use **Finite Elements/Create/Node/Edit** to create the two fixed temperature boundary nodes.
- With **Display/Finite Elements...** or the equivalent Tool Bar function increase the display size of nodes to facilitate boundary definition.
- Use **Loads/BCs/Create/Temperature/Nodal** with **Option: Fixed** to set the boundary node temperatures.
- Use **Loads/BCs/Create/Convection** with **Option: Fixed Coefficient** to apply the contact and nitrogen flow heat transfer coefficients.
- Post only the **device_and_solder** group and use the *middle mouse button* or various **Viewing** functions to expose the individual device surfaces.
- Use **Loads/BCs/Create/Heating** with **Option: Template, Volumetric Heat** to apply the heating load to the individual devices.
- Select **Analysis** to prepare and to submit the model for analysis and to **Read Results**.
- Post **hybrid_fem**, select an **isometric_view**, select **Results**, and review results data.
- **Quit** MSC.Patran.

**Hybrid
microcircuit
boundary
conditions**

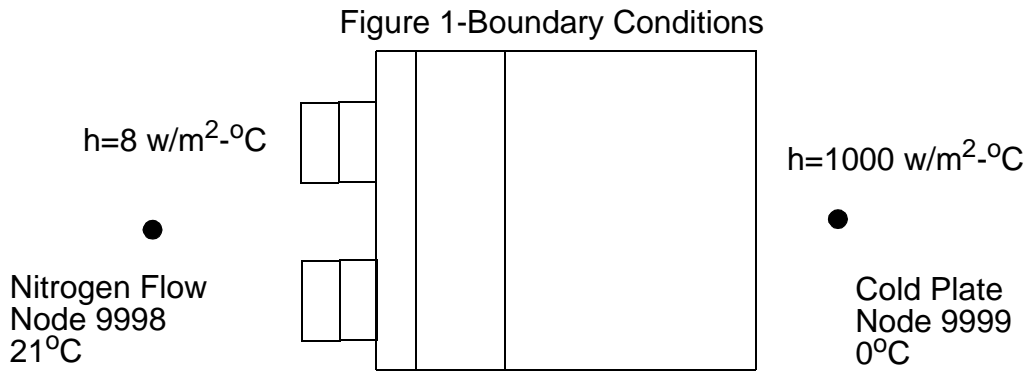


Figure 2-Device Position

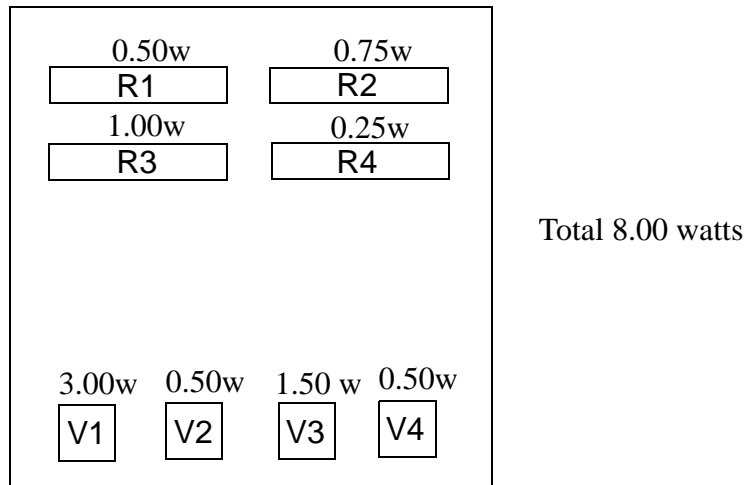


Table 2-Device Heat Generation

Device	w/m ³
R1	0.167E+09
R2	0.250E+09
R3	0.333E+09
R4	0.083E+09
V1	1.500E+09
V2	0.250E+09
V3	0.750E+09
V4	0.250E+09

Exercise Procedure:

1. Open the existing database named **microcircuit.db**.

Within your window environment change directories to the microcircuit.db working directory. Run MSC.Patran by typing **p3** in your xterm window.

Next, select **File** from the *Menu Bar* and open the existing microcircuit database.

Open an existing database

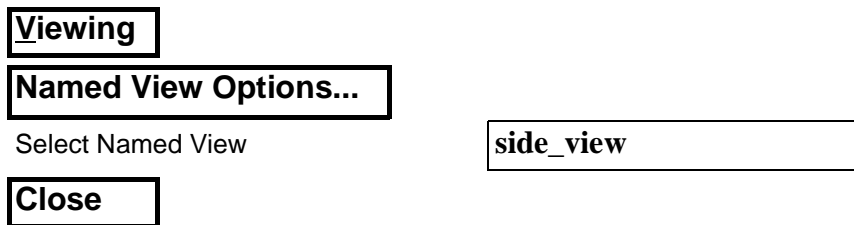


MSC.Patran will open a Viewport and change various *Control Panel* selections from a ghosted appearance to a bold format.

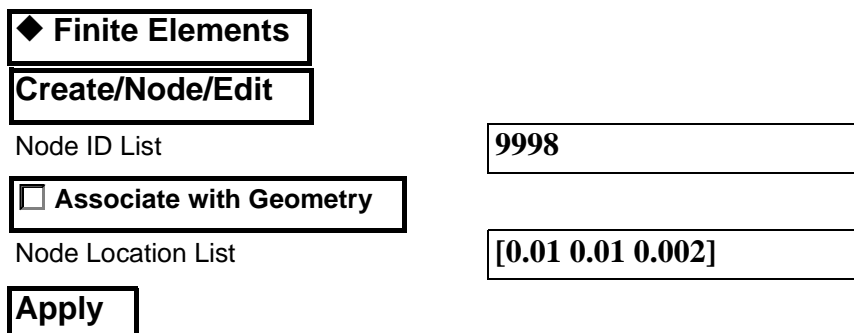
2. Create the two fixed temperature boundary nodes.

Select **Viewing** from the *Menu Bar* or use the Tool Bar *Right Side View* icon to change to a side_view of the model hybrid_fem entities.

Create 2 boundary nodes



Select the **Finite Elements Applications** radio button. Create two nodes which **are not associated with geometry**. The first node is numbered **9998**.



The second node is numbered 9999.

◆ **Finite Elements**

Create/Node/Edit

Node ID List

9999

Associate with Geometry

Node Location List

[0.01 0.01 -0.007]

Apply

**Change
display and
picking
preferences**

3. Increase the display size of nodes and picking preferences to facilitate boundary definition.

Increase the display size of nodes and modify the Picking Preferences to facilitate the application of boundary condition. Use either **Display/Finite Element/Node Size** or the associated Tool Bar icon to change the node size.

Display

Finite Elements...

Node Size (Use Slider Bar)

6

Apply

Cancel

And, select **Preference/Picking...** to change the *Rectangle/Polygon* picking method to **Enclose Centroid**.

Preferences

Picking...

◆ **Enclose Centroid**

Close

Select **Display/ Load/BC/Element Props /Vectors...** to facilitate viewing boundary conditions.

Display

Load/BC/Elem. Props...

Show LBC/EI. Prop Values

<deselect this option>

Vectors/Filters...

Scale Factors:

0.05

Apply

Cancel

Apply

Cancel

4. Fix the boundary node temperatures.

Begin applying boundary conditions. Select the **Loads/BCs Applications** radio button. Create a fixed temperature boundary named **Cold_plate**.

Fix nodal boundary temperatures

◆ Loads/BCs

Create/Temperature/Nodal

Option:

Fixed

New Set Name

Cold_plate

Input Data...

In the Input Data form define the fixed temperature.

Fixed Temperature

0.0

OK

Select Application Region...

In the Select Applications Region form pick node **9999**.

◆ FEM

Select Nodes

<select node 9999>

Add

OK

Apply

Repeat this process for a *New Set Name* **Nitrogen** with a fixed temperature of **21.0** applied to **Node 9998**.

New Set Name	Nitrogen
Input Data...	
Fixed Temperature	21.0
OK	
Select Application Region...	
◆ FEM	
Select Nodes	<select node 9998>
Add	
OK	
Apply	

The display should highlight each node and append the fixed temperature. On some displays the symbol and value may be difficult to discern.

5. Apply contact and nitrogen flow heat transfer coefficients.

Create two convective boundary conditions with the **Use Correlations** option and the heat transfer coefficients provided in Figure 1. Name the first set **nitrogen_flow** and apply the boundary condition to all of the element free faces on the top and sides of **hybrid_fem**.

◆ Loads/BCs	
Create/Convection/Element Uniform	
Option:	Fixed Coefficient
New Set Name	nitrogen_flow
Target Element Type	3D
Region 2	Nodal
Input Data...	

In the Input Data form provide the convection coefficient and fluid node association.

Convection Coefficient	8.0
OK	
Select Application Region...	

Apply convection boundary conditions

In the Select Applications Region form select all the free faces of the top and sides of the model. Exclude the bottom of the model by not enclosing it in the dragged rectangle.

◆ FEM

Application Region /
Select 3D Element Faces

<select all top and side free faces by dragging a rectangle around them, as shown below>

Add

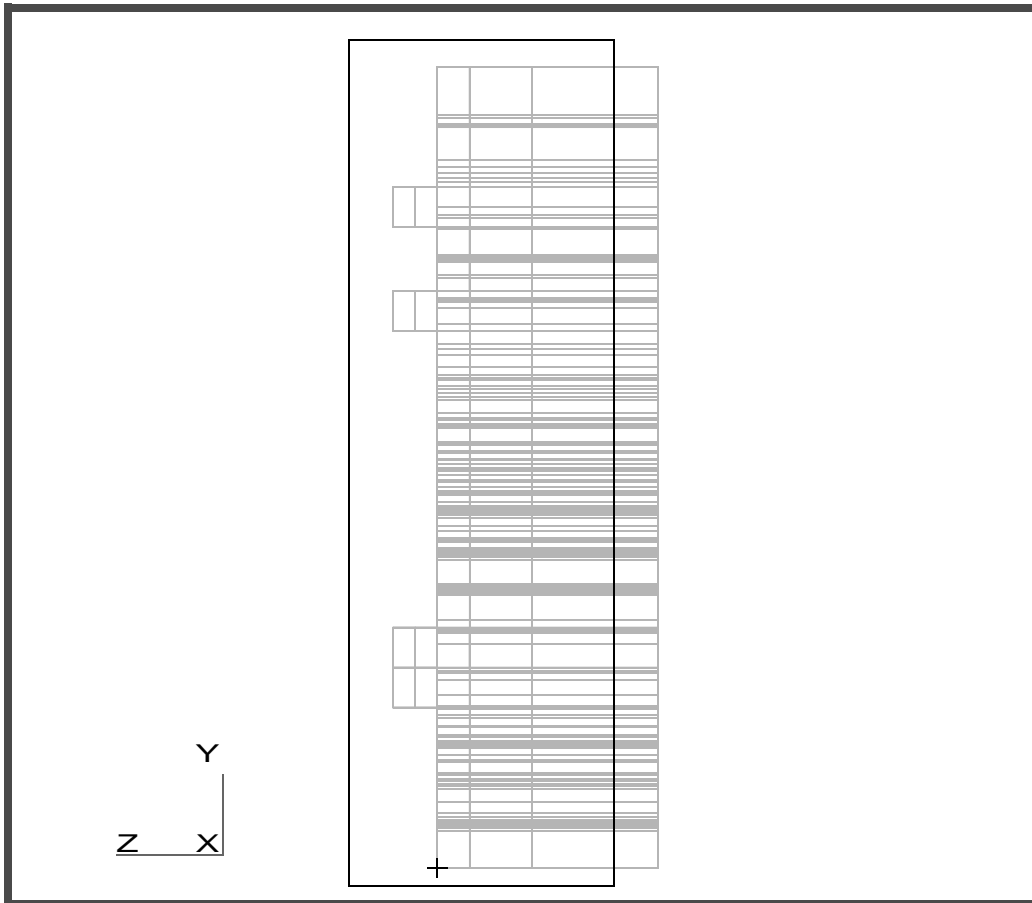
Coupling Region /
Select Nodes

<select node 9998>

Add

OK

Apply



Repeat this process for a *New Set Name* **heat_sink** with a convection coefficient of **1000.0** applied to the bottom surface of the hybrid_fem.

New Set Name

heat_sink

Input Data...

Convection Coefficient

1000.0

OK

Select Application Region...

◆ FEM

Application Region /
Select 3D Element Faces

**<select all bottom free faces by
dragging a rectangle around them>**

Add

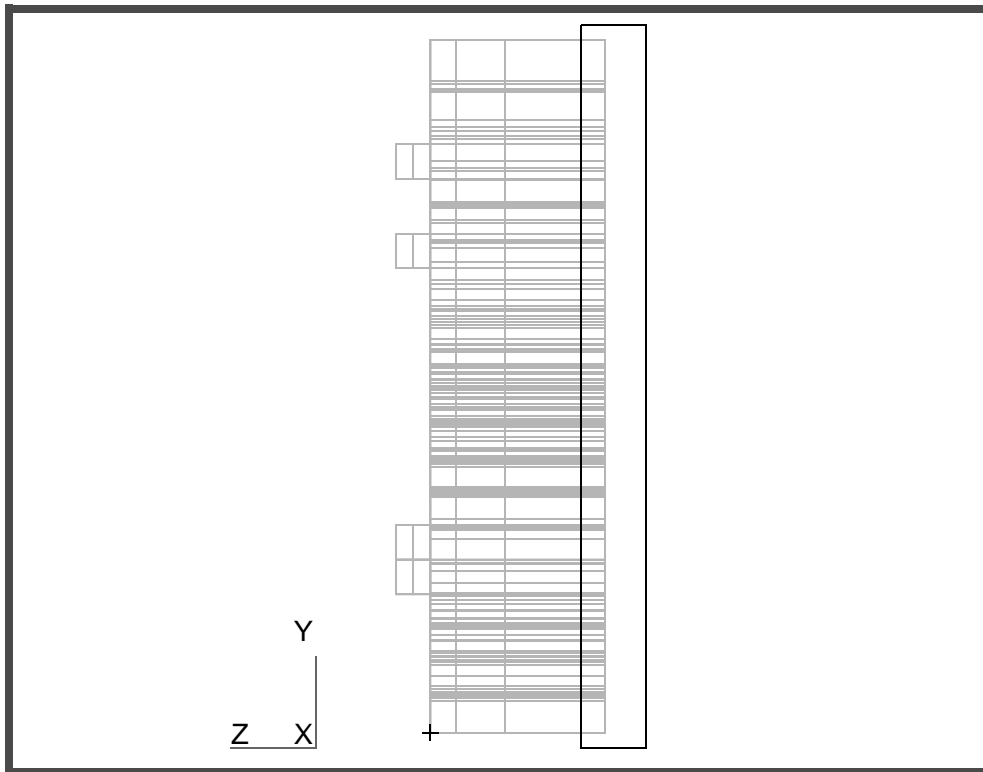
Coupling Region /
Select Nodes

<select node 9999>

Add

OK

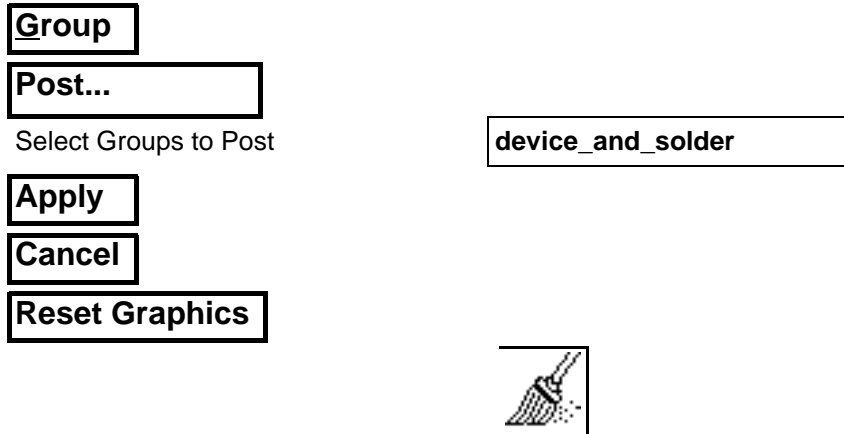
Apply



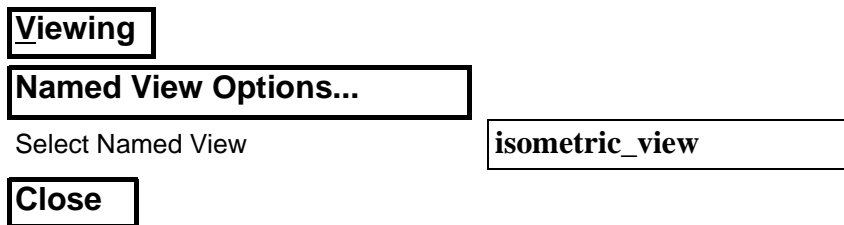
- Post only the **device_and_solder** group and rotate to a view which shows the top device elements

Post only
device_and_
solder

Select **Group/Post...** and **Reset Graphics** to facilitate applying volumetric heat loads.



Select **Viewing** from the *Menu Bar* or use the Tool Bar *Iso 1 View* icon to change to a *isometric_view* of the *device_fem* entities.

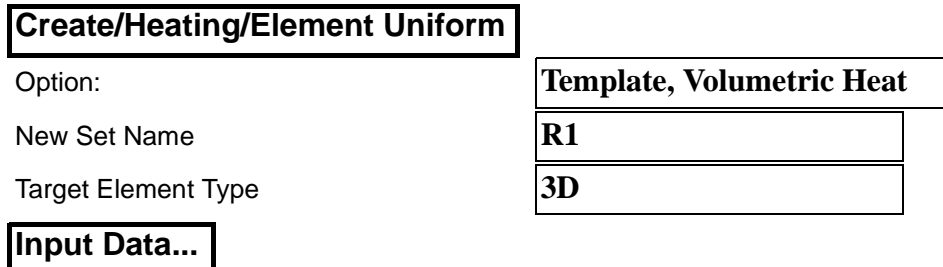


- Apply device volumetric heat loads.

Apply device
volumetric
heat loads

Based on the data in **Table 2** apply volumetric heat loads to **R1** through **V4**, the surface mounted components. The heat load should be placed only on the top layer of elements, the silicon devices.

◆ **Loads/BCs**



Vol Heat Generation

0.167E+09

OK

Select Application Region...

◆ FEM

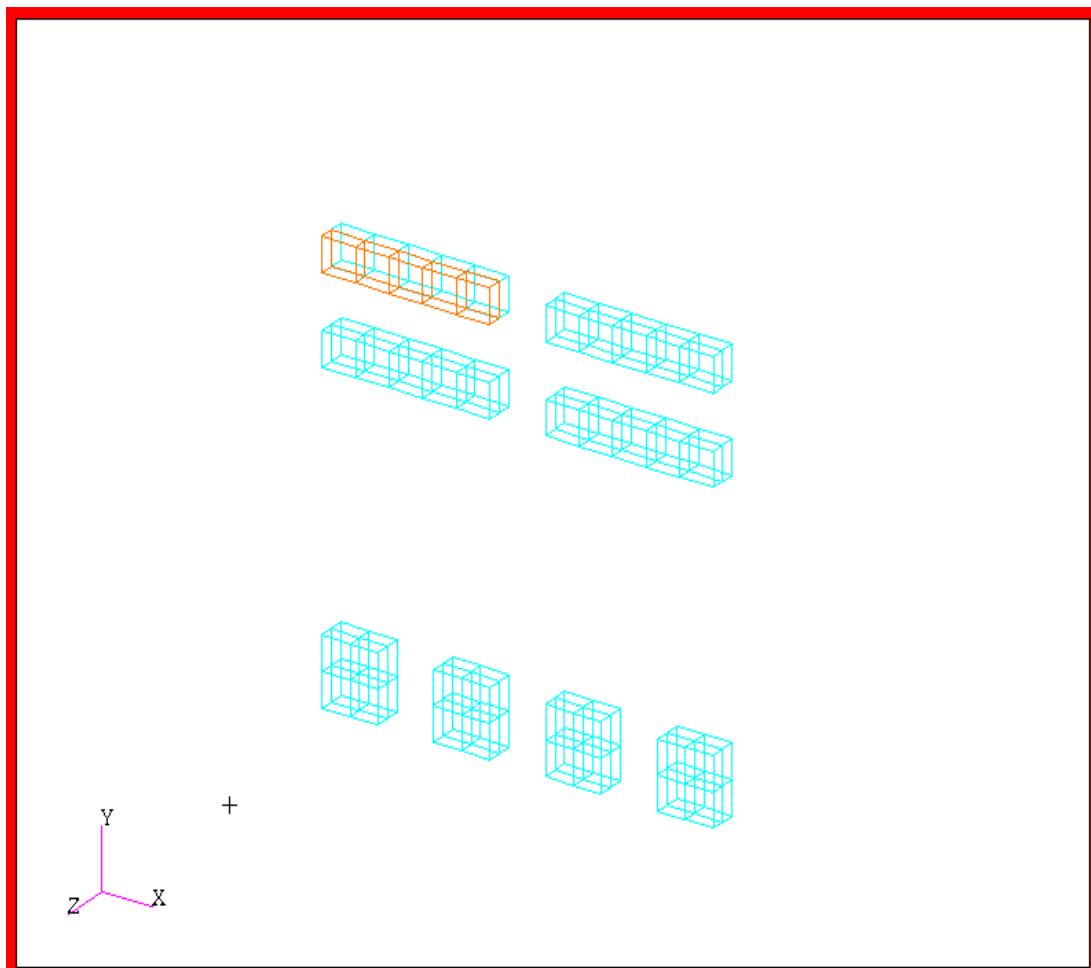
Select 3D Elements

<select the top elements of R1 using shift- left mouse button>

Add

OK

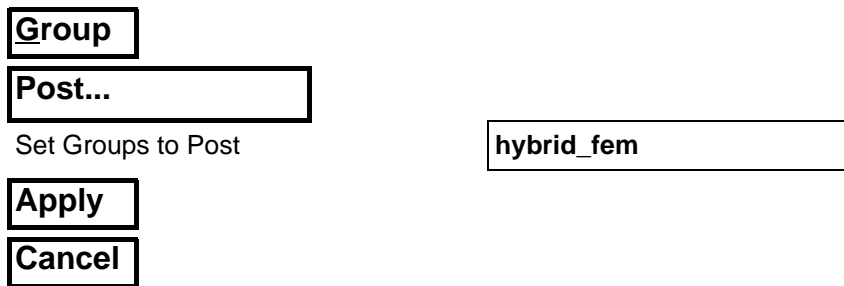
Apply



Repeat the application for *New Set Names R2 through V4*. Use Figure 2 on page 9-4 to correlate heat load to device locations.

The continuous display of LBC markers, vectors and their values should have provided positive indication of the correct application of the LBC's. If you would like to further verify that the two fixed temperature, two heat transfer coefficient, and eight volumetric heating rate LBC's are correctly applied use the **Show Tabular**, **Plot Contours**, and **Plot Markers Action:** selections in the Load/Boundary Conditions form. You may also wish to **Group/Set Current...** different groups to facilitate this LBC's check.

After completing LBC's verification **Group/Set Current... hybrid_fem.**



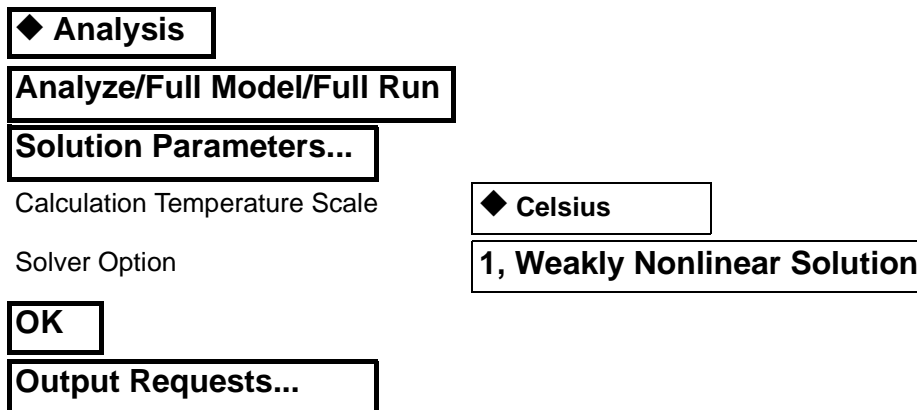
Reduce the node size using the *Node Size* icon and reset graphics defaults using the *Broom* icon.



8. Prepare and submit the model for analysis.

Select the **Analysis Applications radio button** to prepare the analysis. Move through each of the five parameter forms reviewing and changing the settings or selections, if necessary, as shown below. The analysis will be submitted by selecting **Apply** in the Analysis form.

Prepare and run analysis



Units Scale for Output Temperatures

Read and plot results

9. Read results file and plot results.

From within MSC.Patran the only indication that the analysis has successfully finished is the existence of an **nrX.nrf.01** results file in a subdirectory one level below your working directory.

Recall that p3 was initiated from a working directory which contained the **microcircuit.db** database file. The analysis, initiated from within MSC.Patran, created a new subdirectory with the same name as the *Job Name*; it should be named **microcircuit/**. By using **Read Result** in the Analysis form and **Selecting Results File...** you can filter down to the *Job Name* subdirectory and check for the existence of the results file.

◆ Analysis

Directories

Available Files

Files

To plot the results to posted FEM use the **Results Application radio button**.

Select Result Cases

Select Fringe Result

Select the *Fringe Attributes* icon.



Display:

Element Edges

Label Style...

Label Format:

Fixed

Significant figures

3 <use slider bar>

OK

Apply

The model should now appear as shown on the front panel of this exercise.

What is the maximum reported temperature? Is it at or below the required maximum of **50°C**?

10. **Quit** MSC.Patran

To stop MSC.Patran select **File** on the *Menu Bar* and select **Quit** from the drop-down menu.

Quit
MSC.Patran

